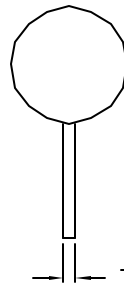
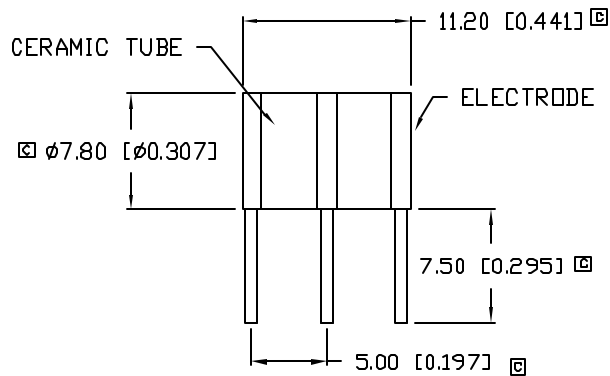


UNCONTROLLED DOCUMENT

PART NUMBER  
GT-CM3230L

REV.  
C

REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10261	10-18-96
B	E.C.N. #10BRDR. & REDRAWN.	3-28-00
C	E.C.N. #10912.	9.23.02



0.80 [0.031]  
TINNED IRON/COPPER  
(3 PLS.)

ELECTRICAL SPECIFICATIONS

PARAMETER	VALUE	TEST CONDITION
D.C. FIRING VOLTAGE:	230V±20% D.C.	(dv/dt 100V/S)
IMPULSE FIRING VOLTAGE:	550V D.C. MAX.	(dv/dt 100V/μS)
IMPULSE CURRENT:	10KA MAX.	(8/20μS)
D.C. HOLDOVER VOLTAGE:	110V D.C. MAX.	(10/1000μS 500A)
A.C. DISCHARGE CURRENT:	65A	(50Hz, 9 CYCLES)
INSULATION RESISTANCE:	10 <sup>4</sup> MΩ MIN.	(50 OR 100VDC)
INTER-ELECTRODE CAPACITANCE:	2.0 PF MAX.	1.0kHz

ENVIRONMENTAL SPECIFICATIONS PER MIL-STD 202

TEST	METHODE	CONDITION	RATING
VIBRATION TESTING:	204B	C	10-55Hz, .06DA
SHOCK	213A	C	100 g
HUMIDITY:	103B	B	95% Re. HUMIDITY
TEMPERATURE CYCLING:	102A	C	-65 TO +125 °C
BAROMETRIC PRESSURE:	105C	B	50,000 ft.
THERMAL SHOCK:	107	B	-65 TO +125 °C
SOLDERABILITY:	208	B	

RESPONSE TIME

SURGE TYPE	(Rt MAX.)
1Kv/mS	1 x 10 <sup>-5</sup> sec.
1Kv/μS	1 x 10 <sup>-8</sup> sec.
5Kv/μS	1 x 10 <sup>-9</sup> sec.

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN. <sup>+DECIMAL PRECISION</sup> <sub>-0.00</sub> MAX. <sup>+0.00</sup> <sub>-DECIMAL PRECISION</sub>

UNCONTROLLED DOCUMENT

REV. C	PART NUMBER GT-CM3230L
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ARRESTOR, 3 LEADED (230 VDC).

RELIABILITY NOTE  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: SK	CHECKED BY:	APPROVED BY:	DATE: 10.6.93 PAGE: 1 OF 1 SCALE: N/A
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